



BM1384

Bitcoin Hash ASIC Datasheet

Bitmain Technologies Limited

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Revision History

Revision Number	Author	Date	Description
1.0	Zhan	2014.9	Initial
2.0	Zhan	2014.11	Update the power performance
2.1	Zhan	2014.12	Update work input timing table.

1 Overview

BM1384 is a kind of high performance and low power consumption bitcoin mining ASIC.

1.1 Features

- Typical hash rate and power

Voltage(V)	Hash Rate(GH/S)	Current(A)	Total power(W)	W/GH
0.80	22.00	12.310	9.848	0.448
0.75	17.88	9.200	6.900	0.386
0.72	15.13	7.440	5.357	0.354
0.70	13.75	6.600	4.620	0.336
0.65	11.00	4.460	2.899	0.264
0.60	8.25	3.430	2.058	0.249

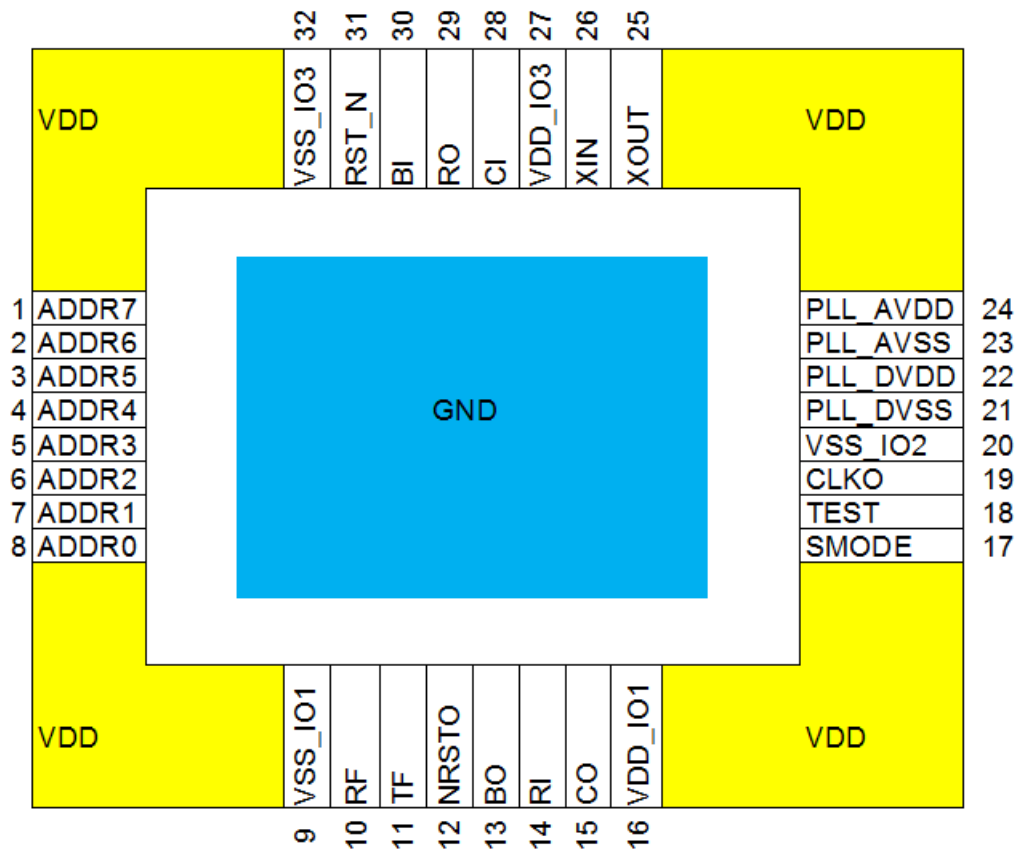
- Customized package
- Support UART communication interface
- Support chain mode, Max 256 chips per chain
- Support hardware addressing and software addressing

1.2 Applications

- Bitcoin mining

2Pin Description

2.1 Pin Diagram



2.2 Signal Description

Name	I/O	Active Level	Description
XIN	I	N/A	Oscillator input
XOUT	O	N/A	Oscillator output
RST_N	I	L	Reset signal
TEST	I	N/A	Internal pull down. 0: Normal mode 1: Test mode
SMODE	I	N/A	Serial Mode. Internal pull up. 0: Asynchronous UART mode. 1: Synchronous UART mode.

Name	I/O	Active Level	Description
CLKOUT	O	N/A	Clock output
NRSTO	O	L	Reset output
CI	I	N/A	Command Input. Schmitt input.
CO	O	N/A	Command Output
RI	I	N/A	Respond Input. Schmitt input and internal pullup.
RO	O	N/A	Respond Output
BI	I	H	Respond Busy Input. Schmit input and internal pulldown.
BO	O	H	Respond Busy Output
ADDR[7:0]			Address Input. Internal pullup.
RF	O		RO open drain output; Command Rx Flag
TF	O		Respond Tx Flag
PLL_AVDD			PLL analog power (1.8V)
PLL_AVSS			PLL analog ground
PLL_DVDD			PLL digital power (0.9V)
PLL_DVSS			PLL digital ground

3 Work Input timing

Clock Freq. (M)	Hash rate (G)	Reg. value	Ideal delay (ms)	Recommend delay (ms)
100	5.500	0783	12.2	11
125	6.875	0983	9.8	9
150	8.250	0b83	8.1	7
175	9.625	0d83	7.0	6
200	11.000	0782	6.1	5
225	12.375	0882	5.4	5
250	13.750	0982	4.9	4
275	15.125	0a82	4.4	4
300	16.500	0b82	4.1	4
325	17.875	0c82	3.8	3
350	19.250	0d82	3.5	3
375	20.625	0e82	3.3	3
400	22.000	08f2	3.0	3
425	23.375	0801	2.9	3
450	24.750	0881	2.7	2

Programming the Output Clock Frequency

$$F_{REF} = F_{IN} / NR$$

$$F_{VCO} = F_{OUT} * NO$$

$F_{OUT} = F_{IN} * NF / (NR * NO)$, where F_{REF} is the comparison frequency for the PFD.

For proper operation in normal mode, the following constraints *must* be satisfied:

Input Divider Value (NR)

$$NR = 16 * R[4] + 8 * R[3] + 4 * R[2] + 2 * R[1] + R[0] + 1 = R[4:0] + 1$$

Feedback Divider Value (NF)

$$NF = 2 * (64 * F[6] + 32 * F[5] + 16 * F[4] + 8 * F[3] + 4 * F[2] + 2 * F[1] + F[0] + 1) = 2 * (F[6:0] + 1)$$

Output Divider Value (NO)

OD[1:0]	00 ₂	01 ₂	10 ₂	11 ₂
NO	1	2	4	8

Table. 4 PLL output divider setting table

High-band

$$25 \text{ MHz} \leq F_{\text{REF}} \leq 50 \text{ MHz}$$

$$1500 \text{ MHz} \leq F_{\text{VCO}} \leq 3000 \text{ MHz}$$

$$187.5 \text{ MHz} \leq F_{\text{OUT}} \leq 3000 \text{ MHz}$$

Low-Band

$$10 \text{ MHz} \leq F_{\text{REF}} \leq 50 \text{ MHz}$$

$$800 \text{ MHz} \leq F_{\text{VCO}} \leq 1600 \text{ MHz}$$

$$100 \text{ MHz} \leq F_{\text{OUT}} \leq 1600 \text{ MHz}$$

4 Electrical Character

4.1 Absolute Maximum Rating

Symbol	Parameter	Max value	Unit
VDD	Core Voltage	1.2	V
VCC	IO Voltage	1.98	V
PLL_DVDD	PLL Digital power	1.2	V
PLL_AVDD	PLL analog Power	1.92	V
T _{STG}	Storage Temperature	-65~150	°C

4.2 Recommended Operation Conditions

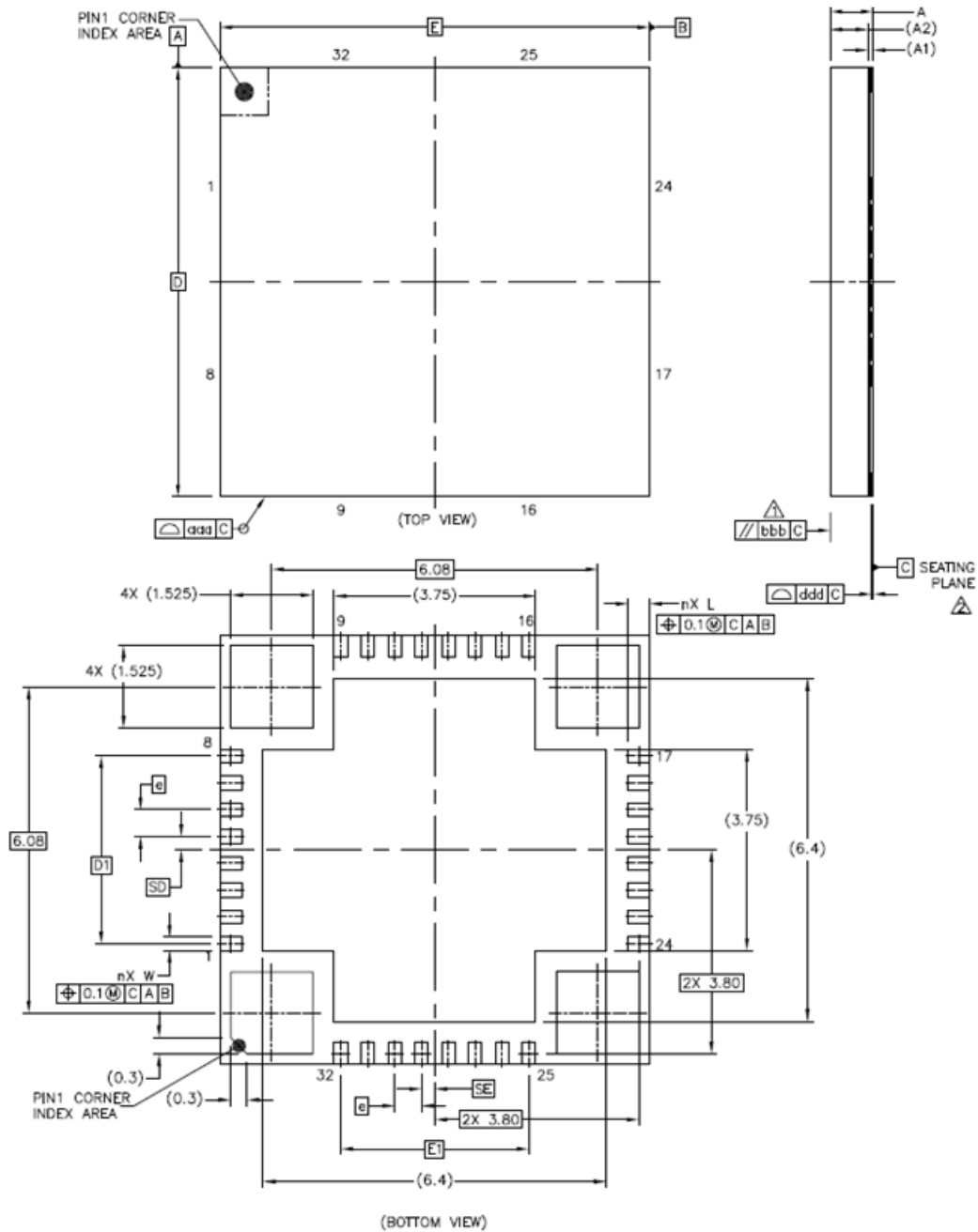
Symbol	Parameter	Min.	Typ.	Max.	Unit
VDD	Core Voltage	0.65	0.8	1.1	V
IO_VDD	IO Voltage	1.62	1.8	1.98	V
PLL_DVDD	PLL Digital power	0.81	0.9	0.99	V
PLL_AVDD	PLL analog Power	1.62	1.8	1.98	V
T _{OPT}	Operation Temperature	0	25	125	°C

4.3 DC Characters

Symbol	Parameter	Min.	Typ.	Max.	Unit
V _{IL}	Input Low Voltage	-0.3		0.63	V
V _{IH}	Input High Voltage	1.17		1.98	V
V _{OL}	Output Low Voltage			0.45	V
V _{OH}	Output High Voltage	1.35			V
I _L	Input Leakage Current			±10	uA
V _T	I/O threshold point	0.81	0.89	0.97	V
V _{T+}	Schmitt input low to high threshold pint	0.95	1.03	1.10	V
V _{T-}	Schmitt input high to low threshold pint	0.64	0.75	0.86	V
R _{PU}	I/O internal pull-up resistor	47K	69K	106K	Ω
R _{PD}	I/O internal pull-down resistor	49K	85K	159K	Ω
I _{CC} (VCC)	Supply current of VCC		10		mA
I _{CC} (PLL)	Supply current of PLL_DVDD and PLL_AVDD		4		mA

CB _{IN}	Input pin capacitance		10		pF
CB _{OUT}	Output pin capacitance		10		pF

5 Package Outline



	SYMBOL	COMMON DIMENSIONS		
		MIN.	NOR.	MAX.
TOTAL THICKNESS	A	---	---	0.85
SUBSTRATE THICKNESS	A1	0.1		REF
MOLD THICKNESS	A2	0.7		REF
BODY SIZE	D	8		BSC
	E	8		BSC
LEAD WIDTH	W	0.2	0.25	0.3
LEAD LENGTH	L	0.35	0.4	0.45
LEAD PITCH	e	0.5		BSC
LEAD COUNT	n	32		
EDGE BALL CENTER TO CENTER	D1	3.5		BSC
	E1	3.5		BSC
BODY CENTER TO CONTACT BALL	SD	0.25		BSC
	SE	0.25		BSC
BALL WIDTH	b	---	---	---
BALL DIAMETER		---		
BALL OPENING		---		
BALL PITCH	e1	---		
BALL COUNT	n1	---		
PRE-SOLDER		---	---	---
PACKAGE EDGE TOLERANCE	aaa	0.1		
MOLD FLATNESS	bbb	0.2		
COPLANARITY	ddd	0.08		
BALL OFFSET (PACKAGE)	eee	---		
BALL OFFSET (BALL)	fff	---		